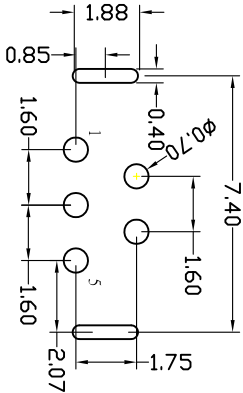
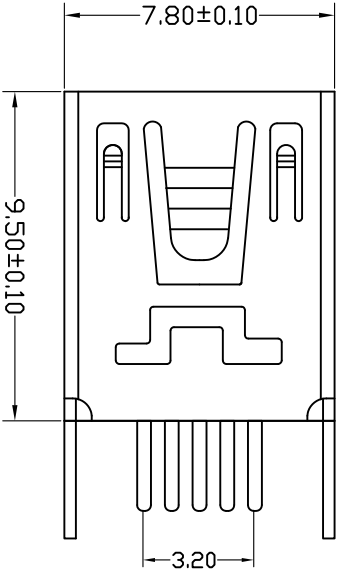
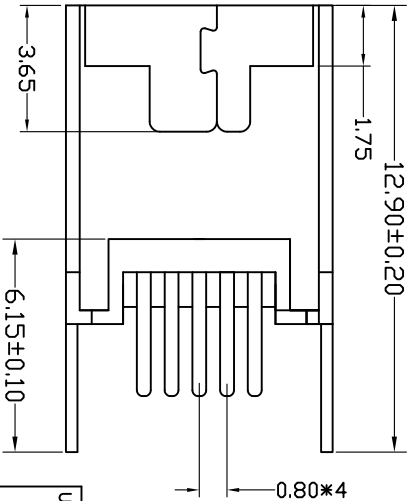
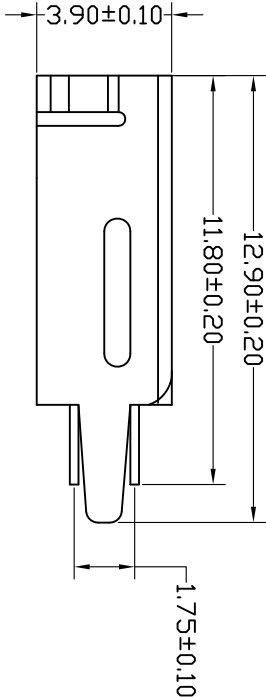
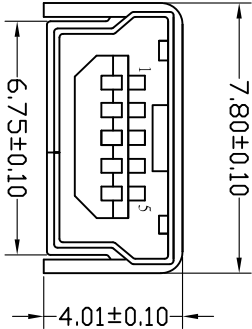


記號 MARK	設 變 內 容 MODIFICATION	日 期 DATE	修 改 DRAW	核 准 APPROVE
△				



RECOMMENDED PCB LAYOUT



特性：Specifications:  
电器：Electrical:

接触阻抗：Contact Resistance 30 milliohms MAX

耐电压：Dielectric Withstanding Voltage: 500V AC AT Sea Level

绝缘阻抗：Insulation Resistance: 100 MEGA ohms MTN

材料：Material:

塑胶：Housing:Hing Temperature Thermoplastics,LCP 耐高温塑胶

端子：Contact :Copper Alloy铜合金

铜壳：Shell:copper Alloy铜合金

电镀：Finish:

端子：Contact:plated Gold in Mating ARaa ;Tin ON Solder Tails

接触点镀金，脚镀锡

铜壳：Shell:

Nickel/Plating 镀镍

UNIT:MM	TYPE:	MODEL NO:	PAGE 1 OF 1
	MINI USB 5Pin/F B TYPE 180° DIP H:9.5	HMUS-F05-VFD-00	SCALE
DESIGNER BY:	May	2012/03/03	VER
CHECK BY:	Sharon	2012/03/03	1
APPROVED BY:	Jason	2012/03/03	



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